

Order Number: MPC7410PEPNS/D Rev. 0, 10/2001

Motorola Part Numbers Affected: XPC7410RX450PE XPC7410RX500PE XPC7410RX550PE



MPC7410 Part Number Specification for the RX*xxx*PE Series

This document describes part-number-specific changes to recommended operating conditions and revised electrical specifications, as applicable, from those described in the general *MPC7410 Hardware Specifications* (order # MPC7410EC/D).

Specifications provided in this document supersede those in the *MPC7410 Hardware Specifications* for the part numbers listed in Table A only. Specifications not addressed herein are unchanged. Because this document is frequently updated, refer to http://www.motorola.com/sps or to your Motorola sales office for the latest version.

Note that headings and table numbers in this document are not consecutively numbered. They are intended to correspond to the heading or table affected in the general hardware specification.

Part numbers addressed in this document are listed in Table A. For more detailed ordering information see Table B.

This document contains information on a new product under development by Motorola. Motorola reserves the right to change or discontinue this product without notice.



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Motorola Part	Operat	ing Condition	S	
Number	CPU Frequency	Vdd T _J (°C		Significant Differences from Hardware Specification
XPC7410RX450PE	450 MHz	2.0V±50mV	0 to 65	Modified voltage and temperature specification to achieve 450Mhz frequency
XPC7410RX500PE	500 MHz	2.0V±50mV	0 to 65	Modified voltage and temperature specification to achieve 500Mhz frequency
XPC7410RX550PE	550 MHz	/Hz 2.0V±50mV 0 to 65		Modified voltage and temperature specification to achieve 550Mhz frequency

Table A	Part Numbers	Addressed by	v this Data	a Sheet
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Note: The X prefix in a Motorola PowerPC part number designates a "Pilot Production Prototype" as defined by Motorola SOP 3-13. These are from a limited production volume of prototypes manufactured, tested and Q.A. inspected on a qualified technology to simulate normal production. These parts have only preliminary reliability and characterization data. Before pilot production prototypes may be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur while shipping pilot production prototypes.

1.2 Features

This section summarizes changes to the features of the MPC7410 described in the MPC7410 Hardware Specifications.

1.4.1 DC Electrical Characteristics

Table 3 provides the recommended operating conditions for the MPC7410 part numbers described herein.

Character	istic	Symbol	Recommended Value	Unit
Core supply voltage		Vdd	2.0V ± 50mV	V
PLL supply voltage		AVdd	2.0V ± 50mV	V
L2 DLL supply voltage		L2AVdd	2.0V ± 50mV	V
Processor bus supply voltage	essor bus supply voltage BVSEL = 1 or BVSEL = HRESET		3.3 ± 165mV	
	BVSEL = HRESET	OVdd	2.5V ± 125mV	V
	BVSEL = GND	OVdd	1.8V ± 90mV	V
L2 bus supply voltage	L2VSEL = HRESET	L2OVdd	2.5V ± 125mV	V
	L2VSEL = GND	L2OVdd	1.8V ± 90mV	V

Table 3. Recommended Operating Conditions



Characte	ristic	Symbol	Recommended Value	Unit
Input voltage	Processor bus	V _{in}	GND to OVdd	V
	L2 Bus	V _{in}	GND to L2OVdd	V
	JTAG Signals	V _{in}	GND to OVdd	V
Die-junction temperature		Тj	0-65	°C

Table 3. Recommended Operating Conditions (Continued)

Note:

These are the recommended and tested operating conditions. Proper device operation outside of these conditions is not guaranteed.

Table 7 provides the power consumption of the MPC7410 part at the frequencies described herein.

	Processor (CPU) Frequency	Processor (CPU) Frequency	Processor (CPU) Frequency	Unit	Notes
	450Mhz	500Mhz	550Mhz		
Full-On Mode		L	L	1	1
Typical	5.9	6.5	7.1	W	1, 3
Maximum	13.2	14.7	16.2	W	1, 2
Doze Mode				I	ł
Maximum	4.5	5	5.5	W	1, 2
Nap Mode		-			
Maximum	2.13	2.25	2.37	W	1, 2
Sleep Mode					
Maximum	2.13	2.25	2.37	W	1, 2
Sleep Mode—PLL and D	LL Disabled				
Typical	0.5	0.5	0.5	W	1, 3
Maximum	2.0	2.0	2.0	W	1, 2

Table 7. Power Consumption for MPC7410

Notes:

- These values apply for all valid processor bus and L2 bus ratios. The values do not include I/O supply power (OVdd and L2OVdd) or PLL/DLL supply power (AVdd and L2AVdd). OVdd and L2OVdd power is system-dependent, but is typically <10% of Vdd power. Worst-case power consumption for AVdd = 15 mw and L2AVdd = 15 mW.
- Maximum power is measured at 65 °C and Vdd = 2.0V while running an entirely cache-resident, contrived sequence of instructions which keep the execution units, including AltiVec, maximally busy.
- 3. Typical power is an average value measured at 65 °C and Vdd = 2.0V in a system while running typical benchmarks.

1.4.2.1 Clock AC Specifications

Table 8 provides the additional clock AC timing specifications described in this document. Refer to the *MPC7410 Hardware Specification* for the remaining frequencies.

Table 8. Clock AC Timing Specifications

At recommended operating conditions (See Table 3)

Characteristic	Symbol	450 MHz		500 MHz		550 MHz		Unit	Notes
Unaracteristic	Gymbol	Min	Max	Min	Max	Min	Max		Notes
Processor frequency	f _{core}	300	450	300	500	300	550	MHz	
VCO frequency	f _{VCO}	600	900	600	1000	600	1100	MHz	
SYSCLK frequency	f _{SYSCLK}	33	133	33	133	33	133	MHz	1
SYSCLK cycle time	t _{SYSCLK}	7.5	30	7.5	30	7.5	30	ns	
SYSCLK rise and fall time	t _{KR}	_	1.0	_	1.0	_	1.0	ns	2
	t _{KF}	_	0.5		0.5	_	0.5	ns	3
SYSCLK duty cycle measured at OVdd/2	t _{KHKL} /t _{SYS} CLK	40	60	40	60	40	60	%	4
SYSCLK jitter		_	±150	_	±150	_	±150	ps	5
Internal PLL relock time		—	100	—	100	—	100	μs	6

Note:

See general hardware specification.



1.4.2.2 Processor Bus AC Specifications

Table 9 provides processor bus AC timing specifications for the MPC7410 part described in this document.

Table 9. Processor Bus AC Timing Specifications

Parameter	Symbol	1	450, 500, 550 Mhz		Notes
		Min	Max		
Mode select input setup to HRESET	t _{MVRH}	8		t sysclk	2,3,4,5
HRESET to mode select input hold	t _{MXRH}	0	_	ns	2,3,5
Setup Times:				ns	10
Address/Transfer Attribute	t _{AVKH}	1.4	—		6
Transfer Start (TS)	t _{TSVKH}	1.4	—		
Data/Data Parity	t _{DVKH}	1.4	_		7
ARTRY/SHD0/SHD1	t _{ARVKH}	1.4	_		_
All Other Inputs	t _{IVKH}	1.4	_		8
Input Hold Times:				ns	11
Address/Transfer Attribute	t _{AXKH}	0	—		6
Transfer Start (TS)	t _{TSXKH}	0	—		—
Data/Data Parity	t _{DXKH}	0	—		7
ARTRY/SHD0/SHD1	t _{ARXKH}	0	—		
All Other Inputs	t _{IXKH}	0	—		8
Valid Times:				ns	12
Address/Transfer Attribute	t _{KHAV}	_	3.0		6
TS, ABB, DBB	t _{KHTSV}	_	3.0		_
Data	t _{KHDV}	_	3.5		7
Data Parity	t _{KHDPV}	_	3.5		7
ARTRY/SHD0/SHD1	t _{KHARV}	_	2.3		_
All Other Outputs	t _{KHOV}	-	3.0		9
Output Hold Times:				ns	13
Address/Transfer Attribute	t _{KHAX}	0.75	_		6
TS, ABB, DBB	t _{KHTSX}	0.75	_		_
Data/Data Parity	t _{KHDX}	0.6	—		7
ARTRY/SHD0/SHD1	t _{KHARX}	0.75			_
All Other Outputs	t _{KHOX}	0.75	_		9
SYSCLK to Output Enable	t _{KHOE}	0.5	—	ns	14
SYSCLK to Output High Impedance (all except TS, ABB/AMON(0), ARTRY/SHD, DBB/DMON(0)	t _{KHOZ}	—	3.5	ns	15

Table 9. Processor Bus AC Timing Specifications (Continued)

Parameter	Symbol	450, 500, 550 Mhz		Unit	Notes	
		Min	Max			
SYSCLK to TS, ABB/AMON(0), DBB/DMON(0) High Impedance after precharge	t _{KHABPZ}	_	1.0	t _{sysclk}	4,15, 16,17	
Maximum Delay to ARTRY/SHD0/SHD1 Precharge	t _{KHARP}		1	t sysclk	4,17	
SYSCLK to ARTRY/SHD0/SHD1 High Impedance After Precharge	t _{KHARPZ}	—	2	t sysclk	4,17	

Note:

See general hardware specification.

1.4.2.3 L2 Clock AC Specifications

Table 10 provides L2CLK output AC timing specifications for the MPC7410 part described in this document.

Table 10. L2CLK Output AC Timing Specifications

At recommended operating conditions (See Table 3)

Parameter	Symbol	450 MHz		500 MHz		550 MHz		Unit	Notes
Falameter	Symbol	Min	Max	Min	Max	Min	Max	Onit	NOLES
L2CLK frequency	f _{L2CLK}	150	225	150	250	150	275	MHz	1
L2CLK cycle time	t _{L2CLK}	4.4	6.67	4.0	6.67	3.64	6.67	ns	
L2CLK duty cycle	t _{CHCL} /t _{L2} CLK	50 50		50 50		0	%	2	
Internal DLL-relock time		640	—	640	_	640	—	L2CLK	4
DLL capture window			±200		±200		±200	ns	5

Note:

See general hardware specification.



1.4.2.4 L2 Bus AC Specifications

Table 11 provides the L2 Bus Interface AC Timing Specifications for the frequencies described in this document.

Table 11. L2 Bus Interface AC Timing Specifications

 $At \ Vdd = AVdd = L2AVdd = 2.05V \pm 50mV; \ 0 \le Tj \le 65^{\circ}C, \ L2OVdd = 2.5V \pm 0.125V \ \text{and} \ L2OVdd = 1.8V \pm 0.090V \ L2OVdd = 1.8V \pm 0.090V$

Parameter	Symbol	450, 50 Mł		Unit	Notes
		Min	Max		
L2SYNC_IN rise and fall time	t _{L2CR} & t _{L2CF}	—	1.0	ns	1
Setup Times: Data and parity	t _{DVL2CH}	1.250		ns	2
Input Hold Times: Data and parity	t _{DXL2CH}	_	0.0	ns	2
Valid Times: All outputs when L2CR[14-15] = 00 All outputs when L2CR[14-15] = 01 All outputs when L2CR[14-15] = 10 All outputs when L2CR[14-15] = 11	t _{L2CHOV}	- - -	2.25 2.50 2.75 3.25	ns	3,4
Output Hold Times All outputs when L2CR[14-15] = 00 All outputs when L2CR[14-15] = 01 All outputs when L2CR[14-15] = 10 All outputs when L2CR[14-15] = 11	t _{L2CHOX}	0.5 0.9 1.3 1.7		ns	3
L2SYNC_IN to high impedance: All outputs when L2CR[14-15] = 00 All outputs when L2CR[14-15] = 01 All outputs when L2CR[14-15] = 10 All outputs when L2CR[14-15] = 11	t _{l2CHOZ}	- - -	2.0 2.5 3.0 3.5	ns	

Note:

See general hardware specification

1.10 Ordering Information

This section regards part numbers and markings.

1.10.1 Part Numbers Addressed by this Specification

Table B provides ordering information for the MPC7410 part described in this document.

XPC	7450	RX	XXX	x	x
Product Code	Part Identifier	Package	Processor Frequency ¹	Application Modifier	Revision Level
XPC ²	7410	RX = CBGA	450 500 550	P: 2.0 V ± 50 mV 0 to 65° C	E: 1.4; PVR = 800C 1104

Table B. Part-Marking Nomenclature

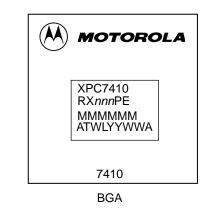
Notes:

1. Processor core frequencies supported by parts addressed by this specification only. Parts addressed by other specifications may support other maximum core frequencies.

2. The X prefix in a Motorola PowerPC part number designates a "Pilot Production Prototype" as defined by Motorola SOP 3-13. These are from a limited production volume of prototypes manufactured, tested, and Q.A. inspected on a qualified technology to simulate normal production. These parts have only preliminary reliability and characterization data. Before pilot production prototypes may be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur while shipping pilot production prototypes.

1.10.2 Part Marking

Parts are marked as shown in Figure A.



Notes:

nnn is the speed grade of the part MMMMMM is the 6-digit mask number ATWLYYWWA is the traceability code

CCCCC is the country of assembly (this space is left blank if parts are assembled in the United States)

Figure A. Motorola Part Marking for BGA Device

Revision Number	Changes
Rev 0	Initial release

Ordering Information



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